# A silicon array for cosmic-ray particle identification in space

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## **OUTLINE**

1) Charge identification using Silicon Matrix

2) Development of a Silicon Matrix Array for Cosmic Nuclei Identification in Space (we proposed this Array for Gamma-400 experiment)

3) Test of Silicon Matrix and associated Front-end Electronics

4) Test of the basic detector module prototype at Cern

5) Data analysis of Beam test data

# **Examples of Silicon charge identifier**

Exemples of experiments where the charge identification of primary cosmic rays is achieved by means of a Si detector with "large" pixels of order 1 cm<sup>2</sup>.



Carbon Target

**BGO** Calorimeter

ATIC

**Balloon Experiment** 

Astroparticle Physics 30 (2008) 133-141 [CREAM]

# **Silicon Charge Detector - Sensor**

- Pixel area: 1.125 × 1.125 cm<sup>2</sup>
- Thickness: 500 μm
- Matrix: 8 × 8 pixels
- Active area: 9.07 × 9.07 cm<sup>2</sup>
- Full area: 9.47 × 9.47 cm<sup>2</sup>
- Full depletion voltage: < 20V
- Breakdown voltage: > 200V
- Dark current per pixel: < ~ 1nA
- Junction capacitance per pixel : ~ 25pF





From SINTEF - Norway



# **Silicon Charge Detector - Sensor**



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# Silicon Charge Detector – Basic Detector Module

Basic module: one pair of aligned sensors + front-end (VAB) board





Basic Module tested at GSI in 2010 end at Cern in 2011,2012 and 2013

## **Silicon Charge Detector - Electronics**

#### <u>VA Board</u>

- Large dynamic range (~1000 MIP)
- · Low-noise : 0.13 MIP (Board level)
- Low-power consumption : 1W
- Number of channels : 128
- · 16bit ADC
- · Gain Distribution:  $3.4 \pm 0.2 \text{ ADU/1fC}$





### A LAYER structure for Gamma400 experiment (concept study)

The GAMMA-400 space mission is included in the long term Russian Federal program for space. The Goal is the observation of high energy gamma rays and the high energy electrons and positrons. But it can be used to measure also the nuclei flux using a charge identification

Lower layer with odd numbered ladders. The upper layer is a complementary structure containing the even numbered ladders. The upper layer is mounted upside-down.

We obtain a seamless structure with no dead zones.





## Silicon Array Readout Concept

ROC = ReadOut Controller: interface to main DAQ and trigger; reads up to 8 ladders

SVAB (Space VA Board) ROC board (up to 16 units in a ladder).



## **Beam Test Experimental Set Up at Cern**

**Bottom Tracker** 

Top Tracker

# Beam tracker layout– CERN 2013



8 layers of strip sensors to measure 4 (x,y) coordinate

- To reduce the number of readout channel for matching VA Board, every 4 strips are ganged to a readout channel
  - The original pitch of the strip is 183µm and the final pitch is 732µm whereby the position resolution is close to 200 micron.
  - 4 Matrix sensors are placed consecutively to obtain a good charge identification. 11

# Analysis of Beam Tracker data – CERN 2013

### □ Tracking:

- Internal tracker alignment between strip sensors
- Chi-square cut on track reconstruction

### □ Rejection of interactions in the beam tracker:

Average of 1° and 2° (before MTX) vs. average of 7° and 8° strip layers

### Charge tagging:

After calibration: use all available dE/dx measurements (up to 4 MTXs + 8 STRIPS)

### TRACKER LAYOUT at the CERN Jan-Feb 2013: ion beam test (H8)



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### CALIBRATIONS OF MATRIX AND SILICON STRIPS



# Rejection of the interactions taking place in the beam tracker

T = average of 1° and 2° strip layers(before MTX); B = average of 7° and 8° strip layers (after MTX);



Cut on the asymmetry A = (B-T)/(T+B)

Non interacting nuclei have A = 0

This cut involves ONLY silicon STRIP layers

Selected events between -0.07 to 0.07

Efficiency of the cut in the tracker selection: 0.731

#### **BEFORE CUT**



### Analysis using 2 Matrix sample



### Analysis using 4 Matrix sample



### **Charge resolution at BCNO group**

Spectrum MTX



### Mean of 2 Matrix

## **Charge Resolution**

$$\Delta Z = \frac{\sigma_Z}{\mu_{Z+1} - \mu_Z}$$

### $\Delta z$ at B $\simeq$ 0.18

Spectrum MTX

Mean of 4 Matrix

 $\Delta z$  at B  $\simeq$  0.15



# Beam tracker charge selection based **only on 8** silicon strip dE/dx samples



After a cluster reconstruction in STRIP, for each strip plane we get the maximum cluster truncated (max  $\pm$  1 strip)

Using 8 dE/dX we obtain a good charge resolution up to Ni demonstrating that Silicon Strips are not useful only for tracking but also for charge identification 19

# **BEAM TRACKER CHARGE TAGGING**

Average of 8 dE/dx measurements with STRIPS vs. Average of 4 dE/dx measurements with silicon MATRIX



Using correlation between STR and MTX we obtain a good separation between nuclei

### Beam tracker charge selection based on 8 silicon strip + 4 MTX pixels dE/dx samples



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### Beam tracker charge selection based on **8 silicon strip + 4 MTX** pixels dE/dx samples



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### MATRIX RESULTS USING 2 MATRIX DETECTORS



### MATRIX RESULTS USING 4 MATRIX DETECTORS



Charge Resolution: 4 Matrix



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## SUMMARY

1) The instrument prototype and associated electronics were capable to provide an excellent charge identification of relativistic nuclei.

2) The dynamic range of the front-end electronics was properly dimensioned to allow a linear response of the system up to the largest charges under test.

3) The correlation of the signals from two layers of Si arrays, placed at different depths in the telescope, is proved to be a powerful tool to identify nuclei interacting in the detector material and allowed to reject them in the data analysis.

 4) Moreover – by combining the response of two separate layers of a Si array – an excellent charge resolution in the range of 0.18–0.30 was achieved from Boron to Carbon